

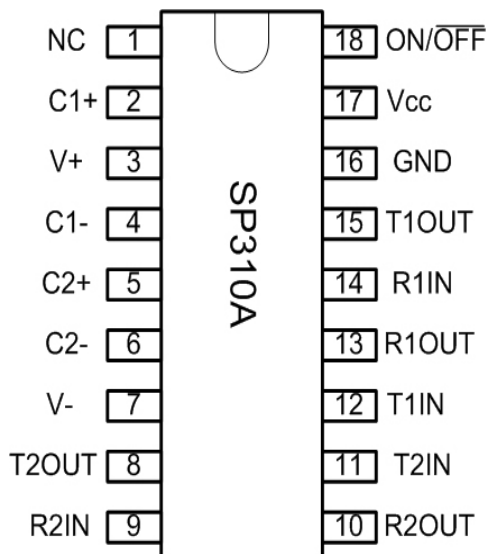


SP233A, SP310A and SP312A

Enhanced RS-232 Line Drivers/Receivers

FEATURES

- Operates from a Single +5V Power Supply
- Meets all RS-232F and ITU V.28 Specifications
- Operates with 0.1 μ F Ceramic Capacitors
- No External Capacitors required (SP233A)
- Low Power Shutdown (SP310A, SP312A)
- High Data Rate - 120kbps under load
- Low power CMOS Operation
- +/-2kV Human Body Model ESD Protection
- Lead Free packaging available



DESCRIPTION

The SP233A / SP310A / SP312A devices are a family of line driver and receiver pairs that meets the specifications of RS-232 and V.28 serial protocols. The devices are pin-to-pin compatible with popular industry standard pinouts. The SP233A / SP310A / SP312A offer 120kbps data rate under load, small ceramic type 0.1 μ F charge pump capacitors and overall ruggedness for commercial applications. Features include Exar's BiCMOS design allowing for low power operation without sacrificing performance. These devices are available in plastic DIP and SOIC Wide packages operating over the commercial and industrial temperature ranges.

SELECTION TABLE

Model	Number of RS-232		No. of RX active in Shutdown	No. of External 0.1 μ F Capacitors	Shutdown	WakeUp	TTL Tri-State
	Drivers	Receivers					
SP233A	2	2	N/A	0	No	No	No
SP310A	2	2	0	4	Yes	No	Yes
SP312A	2	2	2	4	Yes	Yes	Yes

ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below are not implied. Exposure to absolute maximum ratings conditions for extended periods of time may affect reliability.

Supply Voltage (V_{CC}).....+ 6V
 $V+$ ($V_{CC}-0.3V$) to +11.0V
 $V-$-11.0V
 Input Voltages
 T_{IN}-0.3V to ($V_{CC} + 0.3V$)
 R_{IN}+/-30V
 Output Voltages
 T_{OUT}($V+$, +0.3V) to ($V-$, -0.3V)
 R_{OUT}-0.3V to ($V_{CC} + 0.3V$)

Short Circuit duration
 T_{OUT}Continuous
 Package Power Dissipation:
 Plastic DIP.....375mW
 (derate 7mW/°C above +70°C)
 Small Outline.....375mW
 (derate 7mW/°C above +70°C)
 Storage Temperature.....-65°C to +150°C
 Lead Temperature (soldering, 10s).....+300°C

ELECTRICAL CHARACTERISTICS

$V_{CC}=5V \pm 10\%$, 0.1 μF charge pump capacitors, T_{MIN} to T_{MAX} , unless otherwise noted, Typical values are $V_{CC}=5V$ and $T_A=25^\circ C$

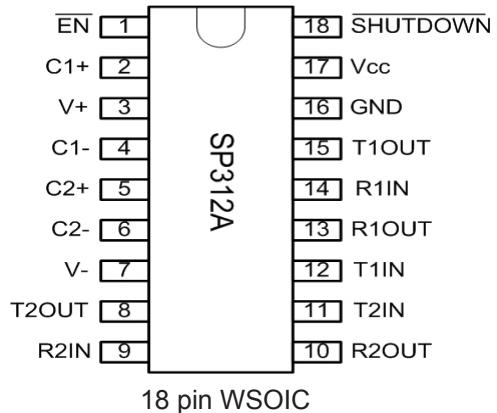
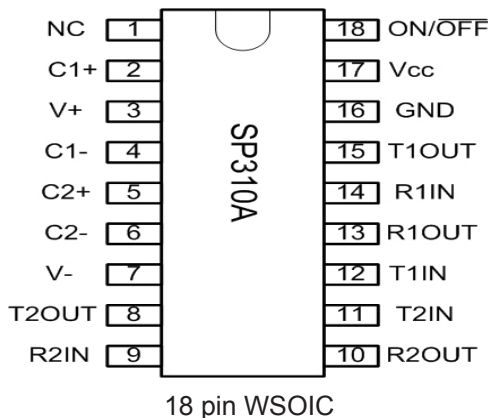
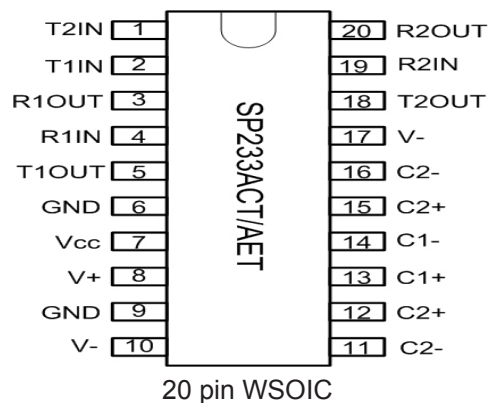
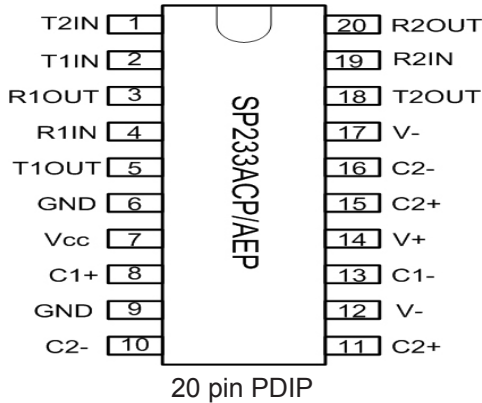
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
TTL INPUT					
Logic Threshold LOW	$T_{IN}, \overline{EN}, \overline{SD}, ON/OFF$			0.8	Volts
Logic Threshold HIGH	$T_{IN}, \overline{EN}, \overline{SD}, ON/OFF$	2.0			Volts
Logic Pull-Up Current	$T_{IN} = 0V$		15	200	μA
TTL OUTPUT					
Output Voltage LOW	$I_{OUT} = 3.2mA; V_{CC} = +5V$			0.4	Volts
Output Voltage HIGH	$I_{OUT} = -1.0mA$	3.5			Volts
Leakage Current; $T_A=25^\circ C$	$\overline{EN} = V_{CC}, 0V \leq V_{OUT} \leq V_{CC}$ SP310A and SP312A only		0.05	+/-10	μA
RS-232 OUTPUT					
Output Voltage Swing	All Transmitter outputs loaded with 3k ohms to GND	+/-5.0	+/-9V		Volts
Output Resistance	$V_{CC} = 0V, V_{OUT} = +/-2V$	300			Ohms
Output Short Circuit Current	Infinite Duration		+/-18		mA
Maximum Data Rate	$CL = 2500pF, RL = 3k\Omega$	120	240		kbps
RS-232 INPUT					
Voltage Range		-25		+25	Volts
Voltage Threshold LOW	$V_{CC} = 5V, T_A=25^\circ C$	0.8	1.2		Volts
Voltage Threshold HIGH	$V_{CC} = 5V, T_A=25^\circ C$		1.7	2.4	Volts
Hysteresis	$V_{CC} = 5V, T_A=25^\circ C$	0.2	0.5	1.0	Volts
Resistance	$T_A=25^\circ C, -25V \leq V_{IN} \leq +25V$	3	5	7	k Ω

ELECTRICAL CHARACTERISTICS

V_{CC}=5V ±10%, 0.1μF charge pump capacitors, T_{MIN} to T_{MAX}, unless otherwise noted, Typical values are V_{CC}=5V and T_A=25°C

Parameter	TEST CONDITIONS	MIN	TYP	MAX	Unit
DYNAMIC CHARACTERISTICS					
Driver Propagation Delay	TTL to RS_232; CL = 50pF		1.5	3.0	μs
Receiver Propagation Delay	RS-232 to TTL,		0.1	1.0	μs
Instantaneous Slew Rate	CL = 10pF, RL = 3-7kΩ			30	V/ μs
Transition Region Slew Rate	CL = 2500pF, RL = 3kΩ; Measured from +3V to -3V or -3V to +3V		10		V/ μs
Output Enable Time	SP310A and SP312A only		400		ns
Output Disable Time	SP310A and SP312A only		250		ns
POWER REQUIREMENTS					
V _{CC} Power Supply Current	No Load, V _{CC} = 5V, T _A =25°C		10	15	mA
V _{CC} Power Supply Current, Loaded	All Transmitters RL = 3kΩ, T _A =25°C		25		mA
Shutdown Supply Current SP310A and SP312A only	V _{CC} = 5V, T _A =25°C		1	10	μA

PIN ASSIGNMENTS



DETAILED DESCRIPTION

The SP233A, SP310A and SP312A devices are a family of line driver and receiver pairs that meet the EIA/TIA-232 and V.28 serial communication protocols. These devices are pin-to-pin compatible with popular industry standards. The SP233A, SP310A and SP312A devices offer a 120kbps data rate, 10V/ μ s slew rate and an on-board charge pump that operates from a single 5V supply using 0.1 μ F ceramic capacitors. The ESD tolerance has been improved on these devices to +/-2kV Human Body Model.

The SP233A device provides internal charge pump capacitors. The SP310A provides an ON/OFF input that simultaneously disables the internal charge pump circuit and puts all transmitter and receiver outputs into a high impedance state. The SP312A is identical to the SP310 but with separate tri-state and shutdown inputs

Theory Of Operation

The SP233A, SP310A and SP312A devices are made up of three basic circuit blocks: 1. Drivers, 2. Receivers, and 3. charge pump.

Drivers

The drivers are inverting level transmitters that convert TTL or CMOS logic levels to EIA/TIA-232 levels with an inverted sense relative to the input logic levels. Typically, the driver output voltage swing is +/-9V. Even under worst case loading conditions of 3k ohms and 2500pF, the driver output is guaranteed to be +/-5.0V minimum, thus satisfying the RS-232 specification. The driver outputs are protected against infinite short-circuits to ground without degradation in reliability.

The drivers can guarantee output data rates of 120kbps under worst case loading of 3k ohms and 2500pF.

The Slew rate of the driver output is internally limited to 30V/ μ s in order to meet the EIA standards (EIA-232F). Additionally, the driver outputs LOW to HIGH transition meets the monotonic output requirements of the standard.

Receivers

The receivers convert EIA/TIA-232 signal levels to TTL or CMOS logic output levels. Since the input is usually from a transmission line, where long cable length and system interference can degrade the signal, the inputs have a typical hysteresis margin of 500mV. This ensures that the receiver is virtually immune to noisy transmission lines. Should an input be left unconnected, an internal 5kohm pull-down resistor to ground will commit the output of the receiver to a HIGH state.

Charge pump

The charge pump is a patented design and uses a unique approach compared to older less efficient designs. The charge pump requires 4 external capacitors and uses a four phase voltage shifting technique. The internal power supply consists of a dual charge pump that provides a driver output voltage swing of +/-9V. The internal oscillator controls the four phases of the voltage shifting. A description of each phase follows:

Phase 1

Vss charge store and double: The positive terminals of capacitors C1 and C2 are charged from Vcc with their negative terminals initially connected to ground. C1+ is then connected to ground and the stored charge from C1- is superimposed onto C2-. Since C2+ is still connected to Vcc the voltage potential across C2 is now 2 x Vcc.

Phase 2

Vss transfer and invert: Phase two connects the negative terminal of C2 to the Vss storage capacitor and the positive terminal of C2 to ground. This transfers the doubled and inverted (V-) voltage onto C4. Meanwhile, capacitor C1 is charged from Vcc to prepare it for its next phase.

Phase 3

Vdd charge store and double: Phase three is identical to the first phase. The positive terminals of C1 and C2 are charged from Vcc with their negative terminals initially connected to ground. C1+ is then connected to ground and the stored charge from C1- is superimposed onto C2-. Since C2+ is still connected to Vcc the voltage potential across capacitor C2 is now 2 x Vcc.

Phase 4

Vdd transfer: The fourth phase connects the negative terminal of C2 to ground and the positive terminal of C2 to the Vdd storage capacitor. This transfers the doubled (V+) voltage onto C3. Meanwhile, capacitor C1 is charged from Vcc to prepare it for its next phase.

The clock rate for the charge pump typically operates at greater than 15kHz allowing the pump to run efficiently with small 0.1uF capacitors. Efficient operation depends on rapid charging and discharging of C1 and C2, therefore capacitors should be mounted as close as possible to the IC and have low ESR (equivalent series resistance). Inexpensive surface mount, ceramic capacitors are ideal for using on charge pump. If polarized capacitors are used the positive and negative terminals should be connected as shown in the typical operating circuit. A diagram of the individual phases are shown in Figure 1.

Shutdown ($\overline{\text{SD}}$) and Enable ($\overline{\text{EN}}$) features for the SP310A and SP312A

Both the SP310A and SP312A have a shutdown / standby mode to conserve power in battery-powered applications. To activate the shutdown mode, which stops the operation of the charge pump, a logic "0" is applied to the appropriate control line. For the SP310A, this control line is the ON/OFF (pin 18) input. Activating the shutdown mode puts the SP310A transmitter and receiver outputs into a high impedance condition. For the SP312A, this control line is the SHUT-DOWN (pin18) input; this also puts the transmitter outputs in a tri-state mode. The receiver outputs can be tri-stated separately during normal operation or shutdown by applying a logic "1" on the $\overline{\text{EN}}$ line (pin 1).

Wake-Up Feature for the SP312A

The SP312A has a wake-up feature that keeps the receivers active when the device is placed into shutdown. Table 1 defines the truth table for the Wake-Up function. When only the receivers are activated, the SP312A typically draws less than 5uA supply current. In the case of when a modem is interfaced to a computer in power down mode, the Ring Indicator (RI) signal from the modem would be used to "wake-up" the computer, allowing it to accept data transmission.

After the ring indicator has propagated through the SP312A receiver, it can be used to trigger the power management circuitry of the computer to power up the microprocessor, and bring the $\overline{\text{SD}}$ pin of the SP312A to a logic high, taking it out of the shutdown mode. The receiver propagation delay is typically 1us. The enable time for V+ and V- is typically 2ms. After V+ and V- have settled to their final values, a signal can be sent back to the modem on the data terminal ready (DTR) pin signifying that the computer is ready to accept the transmit data.

$\overline{\text{SD}}$	$\overline{\text{EN}}$	Power Up/Down	Receiver outputs
0	0	Down	Enabled
0	1	Down	Tri-state
1	0	Up	Enabled
1	1	Up	Tri-state

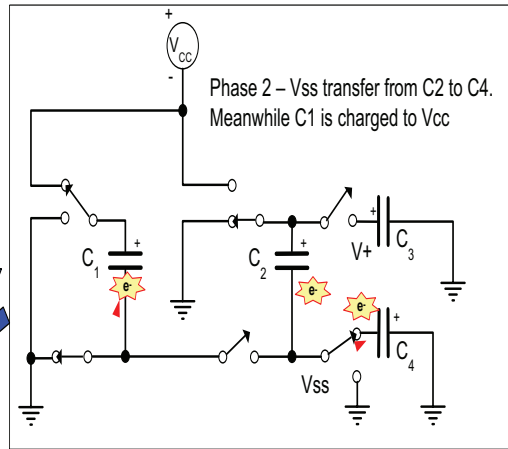
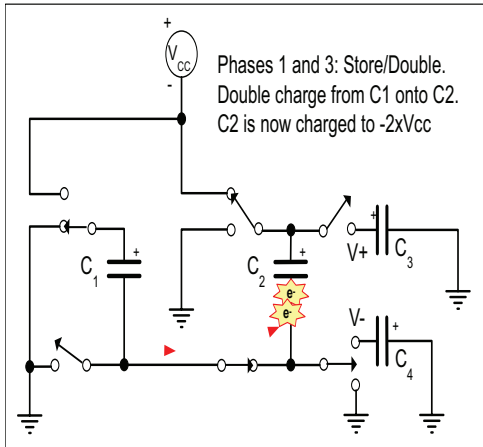
Table 1. Wake-up Function truth table

Pin Strapping for the SP233ACT/ACP

The SP233A packaged in a 20 pin SOICW package (SP233ACT) has a slightly different pinout than the SP233A in PDIP packaging (SP233ACP). To operate properly, the following pairs of pins must be externally wired together as noted in table 2:

Pins Wired Together	SOICW	PDIP
Two V- pins	10 & 17	12 & 17
Two C2+ pins	12 & 15	11 & 15
Two C- pins	11 & 16	10 & 16
	No Connections for Pins 8, 13 and 14	
	Connect Pins 6 and 9 to GND	

Table 2. Pin Strapping table for SP233A



Patented 5,306,954

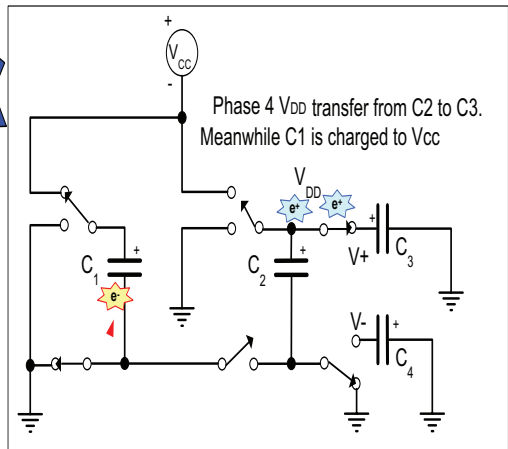


Figure 1. Charge pump phases

TYPICAL PERFORMANCE CHARACTERISTICS

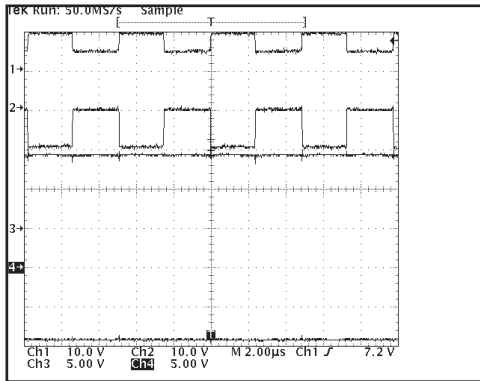


Figure 2, SP233A Charge pump waveforms-no load (1 = C1+, 2 = C2+, 3 = V+, 4 = V-).

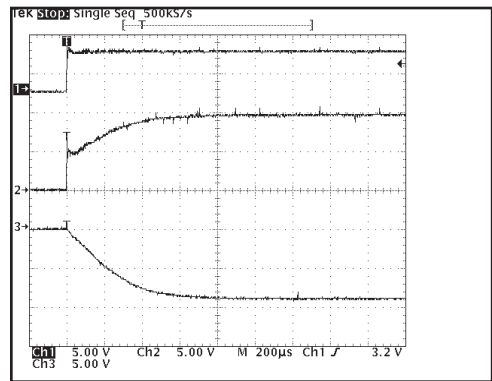


Figure 5, Charge pump outputs at start up (1 = Vcc, 2 = V+, 3 = V-).

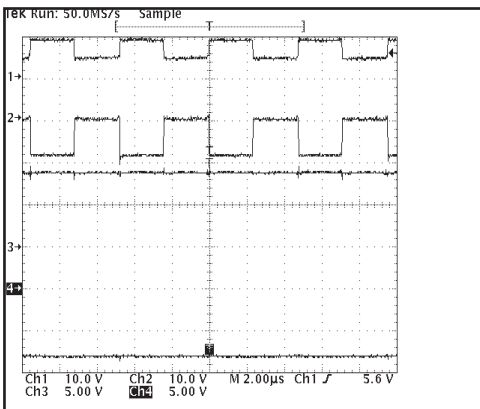


Figure 3, SP233A Charge pump waveforms when fully loaded with 3Kohms (1 = C1+, 2 = C2+, 3 = V+, 4 = V-).

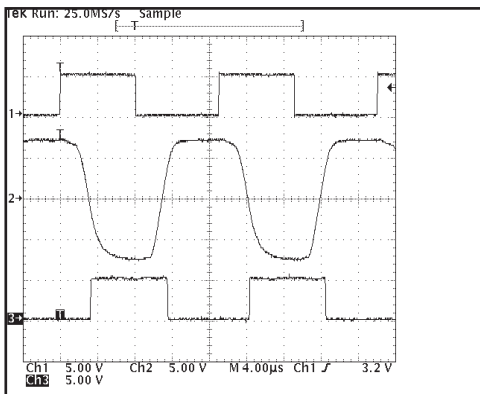


Figure 4, Loopback results at 60KHZ and 2500pF load (1 = TXin, 2 = TXout/RXin, 3 = RXout).

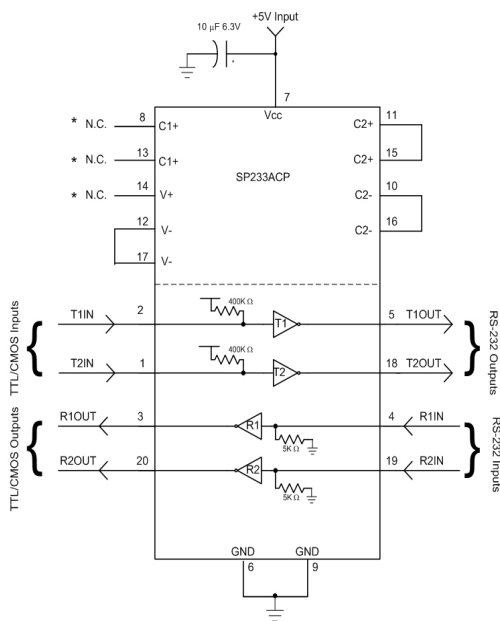


Figure 6, SP233ACP Typical Application circuit

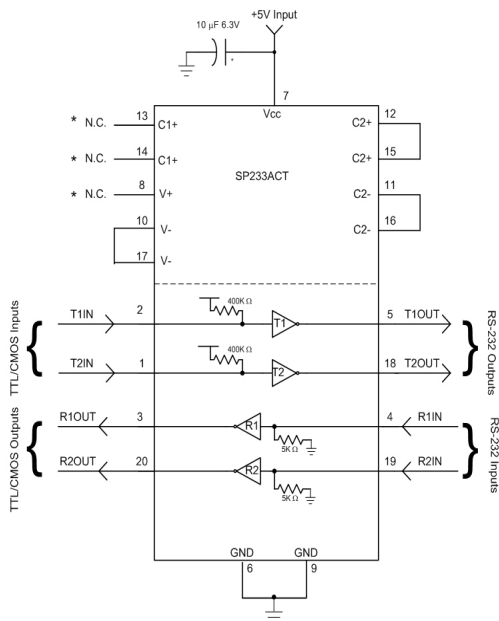


Figure 8, SP233ACT Typical Application circuit

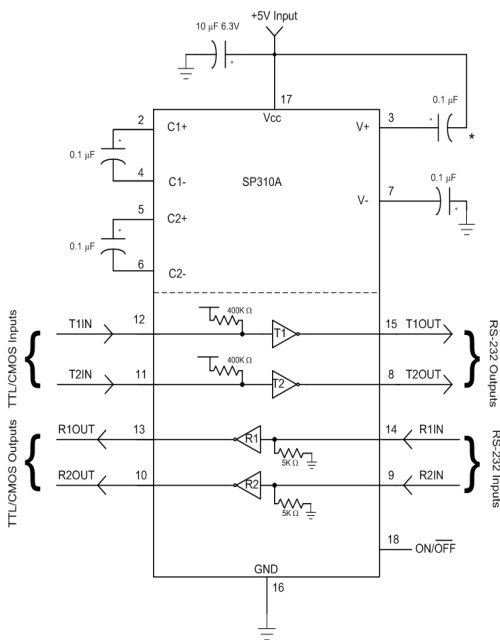


Figure 7, SP310A Typical Application circuit

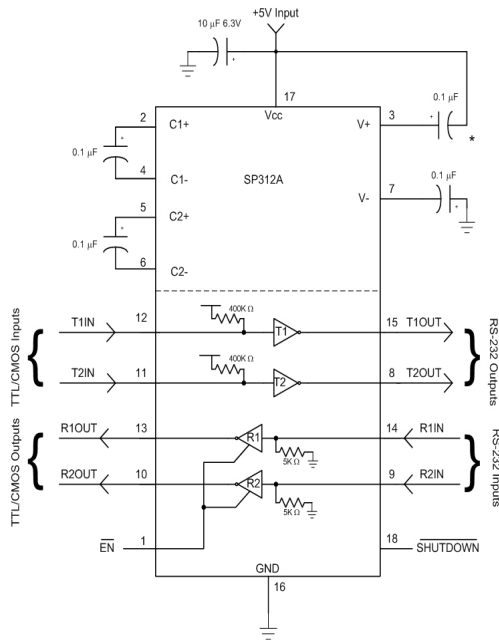
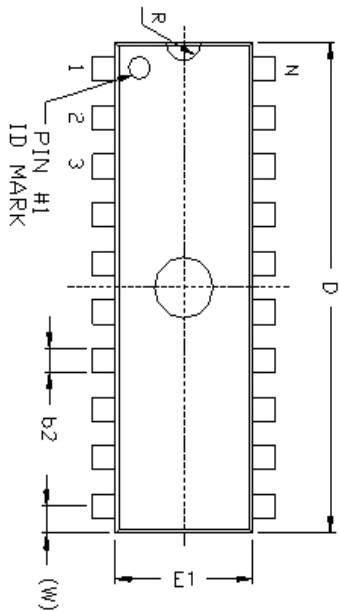
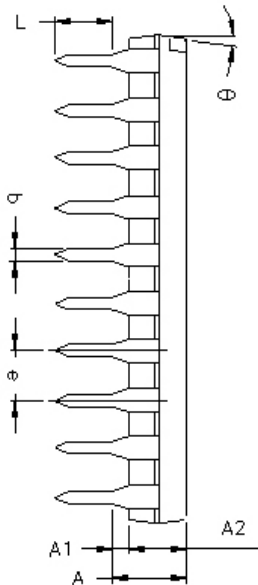


Figure 9, SP312A Typical Application circuit

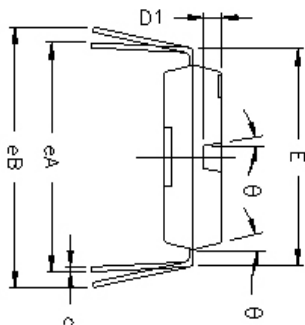
REMARKS:
FOR 8LD AND 16LD
ALL END LEADS (4X)
ARE HALF LEAD TYPES



Top View



Side View



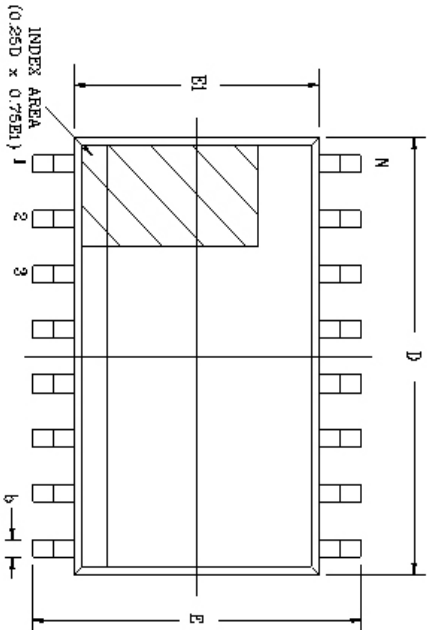
Front View

20 Pin PDIP JEDEC MS-001 Variation AD						
DIMENSIONS IN INCH (Control Unit)						
DIMENSIONS IN MM (Reference Unit)						
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	0.210	—	—	5.33
A1	0.015	—	—	0.38	—	—
A2	0.115	0.130	0.195	2.92	3.30	4.95
b	0.014	0.018	0.022	0.36	0.46	0.56
b2	0.045	0.060	0.070	1.14	1.52	1.78
c	0.008	0.010	0.014	0.20	0.25	0.36
D1	0.030	—	0.060	0.76	—	1.52
E	0.300	0.310	0.325	7.62	7.87	8.26
E1	0.240	0.250	0.280	6.10	6.35	7.11
e	0.100	BSC	—	2.54	BSC	—
eA	0.300	BSC	—	7.62	BSC	—
eB	—	—	0.430	—	—	10.92
L	0.115	0.130	0.150	2.92	3.30	3.81
W	0.075	REF	—	1.91	REF	—
R	0.030	BSC	—	0.76	BSC	—
theta	4°	7°	10°	4°	7°	10°
D	0.980	1.030	1.060	24.89	26.16	26.92
N	20	20	20	20	20	20

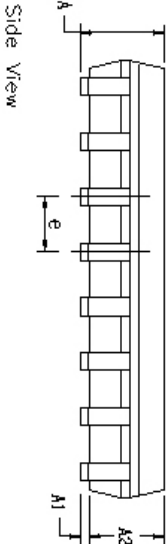
REVISION HISTORY			
REV.	DESCRIPTION	DATE	APPRO.
A	DRAWING ORIGINATOR	04/28/06	JL
B	CHANGE DRAWING LOGO AND COMPANY NAME	11/27/07	JL

		EXAR CORPORATION	
Packaging Approval:		20 PIN PDIP PACKAGE OUTLINE	
By JL	Date 11/27/07	Drawing No:	20-PIN PDIP
Revision: B		Sheet: 1 OF 1	

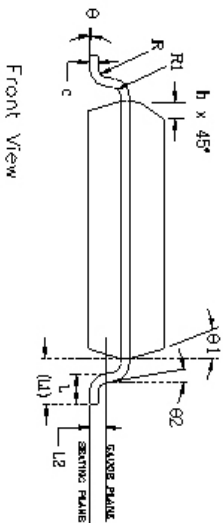
REVISION HISTORY			
REV.	DESCRIPTION	DATE	APP'D
A	DRAWING ORIGINATOR	04/24/06	JL
B	CHANGE DRAWING LOGO AND COMPANY NAME	11/28/07	JL



Top View



Side View

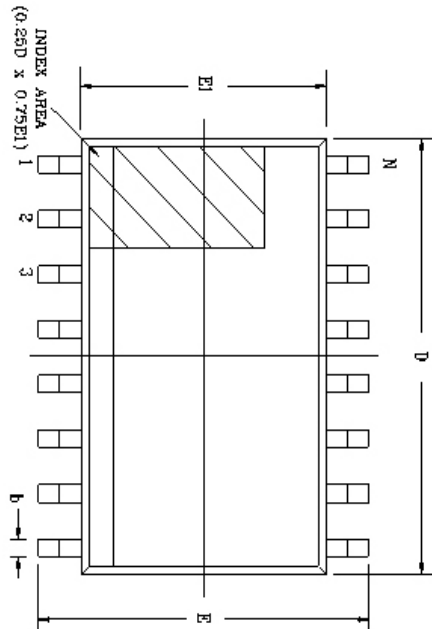


Front View

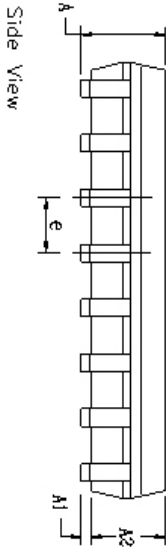
20 Pin SOICW JEDEC MS-013 Variation AC						
SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	2.35	—	2.65	0.093	—	0.104
A1	0.10	—	0.30	0.004	—	0.012
A2	2.05	—	2.55	0.081	—	0.100
b	0.31	—	0.51	0.012	—	0.020
c	0.20	—	0.33	0.008	—	0.013
E	10.30 BSC			0.406 BSC		
E1	7.50 BSC			0.295 BSC		
e	1.27	BSC	—	0.050 BSC		
h	0.25	—	0.75	0.010	—	0.030
L	0.40	—	1.27	0.016	—	0.050
L1	1.40 REF			0.055 REF		
L2	0.25 BSC			0.010 BSC		
R	0.07	—	—	0.003	—	—
R1	0.07	—	—	0.003	—	—
θ	0°	—	8°	0°	—	8°
θ1	5°	—	15°	5°	—	15°
θ2	0°	—	—	0°	—	—
D	12.80 BSC			0.504 BSC		
N	20			20		

		EXAR CORPORATION	
		20 PIN SOICW PACKAGE OUTLINE	
By: JL	Date: 11/28/07	Drawing No: 20-PIN SOICW	Sheet: 1 OF 1

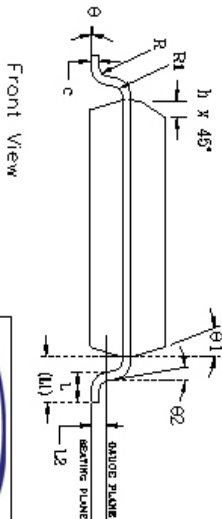
REVISION HISTORY			
REV.	DESCRIPTION	DATE	APP'D.
A	DRAWING ORIGINATOR	04/24/06	JL
B	CHANGE DRAWING LOGO AND COMPANY NAME	11/21/07	JL



Top View



Side View



Front View

18 Pin SOICW JEDEC MS-013 Variation AB									
SYMBOLS	DIMENSIONS IN MM (Control Unit)				DIMENSIONS IN INCH (Reference Unit)				
	MIN	NOM	MAX		MIN	NOM	MAX		
A	2.35	—	2.65	0.093	—	0.104	—		
A1	0.10	—	0.30	0.004	—	0.012	—		
A2	2.05	—	2.55	0.081	—	0.100	—		
b	0.31	—	0.51	0.012	—	0.020	—		
c	0.20	—	0.33	0.008	—	0.013	—		
E	10.30 BSC				0.406 BSC				
E1	7.50 BSC				0.295 BSC				
e	1.27 BSC				0.050 BSC				
h	0.25	—	0.75	0.010	—	0.030	—		
L	0.40	—	1.27	0.016	—	0.050	—		
L1	1.40 REF				0.055 REF				
L2	0.25 BSC				0.010 BSC				
R	0.07	—	—	0.003	—	—	—		
R1	0.07	—	—	0.003	—	—	—		
θ	0°	—	8°	0°	—	8°	—		
θ1	5°	—	15°	5°	—	15°	—		
θ2	0°	—	—	0°	—	—	—		
D	11.55 BSC				0.455 BSC				
N	18				18				

		EXAR CORPORATION	
Packaging Approval:		18 PIN SOICW PACKAGE OUTLINE	
By: JL	Date: 11/21/07	Drawing No:	18-PIN SOICW
Revision: B		Sheet:	1 OF 1

Part number	LEAD FREE	Tape & Reel	Temperature range	Package Type
SP233ACP	-L		From 0 to +70°C	20 pin PDIP
SP233AEP	-L		From -40 to +85°C	20 pin PDIP
SP233ACT	-L	/TR	From 0 to +70°C	20 pin SOICW
SP233AET	-L	/TR	From -40 to +85°C	20 pin SOICW
SP310ACT	-L	/TR	From 0 to +70°C	18 pin SOICW
SP310AET	-L	/TR	From -40 to +85°C	18 pin SOICW
SP312ACT	-L	/TR	From 0 to +70°C	18 pin SOICW
SP312AET	-L	/TR	From -40 to +85°C	18 pin SOICW

All packages are available as lead free (RoHS compliant). To order add “-L” suffix to part number. For Tape and Reel add “/TR”. Reel quantity is 1,500 for SOICW.

Example: SP233ACT-L/TR = lead free and Tape and Reel. SP233ACT/TR = standard with Tape and Reel.

REVISION HISTORY		
Date	Revision	Description
1-31-07	Rev B	Original SP232A/233A/310A/312A Sipex Data sheet
5-13-08	100	Generate new SP233A/310A/312A Data sheet using Exar format.
6-03-11	101	Add Revision History table. Remove SP310ACP-L option per PDN 110510-01.

Notice

EXAR Corporation reserves the right to make changes to any products contained in this publication in order to improve design, performance or reliability. EXAR Corporation assumes no representation that the circuits are free of patent infringement. Charts and schedules contained herein are only for illustration purposes and may vary depending upon a user's specific application. While the information in this publication has been carefully checked; no responsibility, however, is assumed for inaccuracies.

EXAR Corporation does not recommend the use of any of its products in life support applications where the failure or malfunction of the product can reasonably be expected to cause failure of the life support system or to significantly affect its safety or effectiveness. Products are not authorized for use in such applications unless EXAR Corporation receives, in writing, assurances to its satisfaction that: (a) the risk of injury or damage has been minimized ; (b) the user assumes all such risks; (c) potential liability of EXAR Corporation is adequately protected under the circumstances.

Copyright 2011 EXAR Corporation

Datasheet June 2011

Send your serial transceiver technical inquiry with technical details to: serialtechsupport@exar.com

Reproduction, in part or whole, without the prior written consent of EXAR Corporation is prohibited.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9